Update on Energy Dispersive X-ray Spectrometry with the Silicon Drift Detector (SDD) and Microstructural Characterization with NIST Lispix

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Advanced Instrumental Techniques and Software Algorithms in EPMA Workshop

Certain commercial equipment, instruments, or materials are identified in this talk to foster understanding. Such identification does not imply recommendation or endorsement by the National Institute of Standards and Technology, nor does it imply that the materials or equipment identified are necessarily the best available for the purpose.

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At the 2006 M&M Conference in Chicago, I gave the following paper:

50 years of x-ray mapping: a tribute to Peter Duncumb

X-ray Mapping in the Spectrum Image Mode at Output Count Rates above 100 kHz with the Silicon Drift Detector (SDD)

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The new EDS: Silicon Drift Detector (SDD)

This paper examined the performance of the SDD for various parameters but especially for high speed X-ray Spectrum Imaging (XSI).



The new EDS: Silicon Drift Detector (SDD)

This paper examined the performance of the SDD for various parameters but especially for high speed X-ray Spectrum Imaging (XSI).

But as I gave the paper, I was already aware (thanks to July '06 communication from Joe Michael at Sandia) that my results were stale: 100 kHz OCR was already way behind the limiting performance envelope for SDD technology.

What had happened?



The Si(Li) Energy Dispersive X-ray Spectrometer

Fitzgerald, R, Keil, K. and Heinrich, K. Science v 159 (1968) 528 "Solid-State Energy-Dispersion Spectrometer for Electron-Microprobe X-ray Analysis"

EDS Mapping Advantages:

1. Detects entire x-ray spectrum enabling mapping of all elements simultaneously

- 2. The unexpected can be discovered!
- 3. No defocusing Disadvantages

 Poor resolution: interferences
Lower P/B; more susceptible to continuum effects; poorer limits of detection
OCR: 2 kHz to 20 kHz







Photon Energy (keV)

Spectrum appears to be continuously measured at all energies, but it is actually one photon at a time: deadtime

Drastic decrease

in detector efficiency

X-ray detection

Current State-of-the Art Si(Li)-EDS (30 mm²)



Current digital signal processing with conventional Si-EDS enables count rates > 30 kHz (40% DT) with FWHM of ~180 eV (MnK α)



Current State-of-the Art Si(Li)-EDS (30 mm²)





Conventional Si(Li) EDS with Liquid nitrogen cooling to -190 °C **SDD EDS with thermoelectric** cooling to ~ -20 to -50 °C ASPE

3rd generation Radiant "Vortex" 50 mm² SDD





Rate (counts/s

Output Count







Detector solid angle plus processing speed revolutionizes x-ray mapping!



The Real Promise of the SDD: High Speed Spectrum Image Mapping

"Three-minute egg x-ray spectrum image"

Radiant SDD/SAMx spectrum imaging software 128x128x10ms (1.3 ms overhead) = 185 s total $50 \text{ mm}^2 \text{ detector}; 500 \text{ ns time constant}; \text{ Res} = 188 \text{ eV}$ $(MnK\alpha)$ $E_0 = 20 \text{ keV} \text{ i} = 10nA$ ICR: 320 kHz OCR: 220 kHz ~40%DT



Raney Nickel Alloy $E_0 = 20 \text{ keV } 10 \text{ nA}$ TC = 500 ns (188 eVat MnK α) 128x128 10 ms per pixel Mapping 185 sec

Phases Al 99.5 Ni 0.5 Al 71.2 Ni 24.6 Fe 4.2 Al 60 Ni 40 "I" Al 46.5 Ni 53.5 "H"



Update on Silicon Drift Detector (SDD) Performance

• Processing speed

Joe Michael's news: he had obtained a quad detector with this performance!

Bruker SDD Performance

| Detector rise time | <100ns |
|----------------------|---|
| Optimum shaping time | 700 ns (90 kcps max. throughput) |
| Maximum cooling | $-25^{\circ}C$ (at Iopt=2,5A, ta = 23°C, still air) |
| Thermostat set point | -20°C |

Values for sum spectrum over all 4 detectors (measured at MnKa)

| T | | |
|--|--------|--------------|
| Peak/Background | 2200:1 | than Si(Li)! |
| Peak drift (24h) | <10eV | 100x faster |
| Peak shift $(20 \dots 800 \text{ kcps}) < 5 \text{eV}$ | | |

Energy resolution and processed countrate of 5.899 keV, Mn k

| Energy resolution and processed countrate of 5.899 keV, Mn k α | | | | |
|---|------------------------|-------------------------|-----------------------|-------|
| shaper throughput | input <u>countrate</u> | output <u>countrate</u> | FWHM (<u>Mn</u> k α) | ъD |
| 90kcps | 20kcps | 19kcps | 127eV | -25°C |
| 90kcps | 400kcps | | | -20°C |
| 130kcps | 400kcps | 300kcps | 131eV | -20°C |
| 275kcps | 400kcps | 352kcps | 150eV | -20°C |
| 275kcps | 1000kcps | 718kcps | 150eV | -20°C |

Acquisition conditions: excitation at Fe55 radiation

Source: Bruker

The latest SDD (Bruker 4th generation)



Bruker: single SDD performance

Four 10 mm² SDDs with multiplexing gives OCR > 1 MHz with resolution < 140 eV.

Bruker Quad SDD Data: Joe Michael, Sandia National Lab Albuquerque, NM

But wait! The latest SDD (Bruker 4th generation)



Why is this SDD so much faster?

Bruker "Tear-drop" Shaped SDD

OCR speed: On-chip integrated charge amplifier eliminates microphonics; off-center location protects amplifier from x-rays



M&M2005_Optimized Readout Methods of Silicon Drift Detectors for High Resolution Spectroscopy in Micro-Beam Analysis

H.Soltau*, P.Lechner*, A. Niculae*, G. Lutz**, L. Strüder**, C. Fiorini*** and A. Longoni *** R. Eckhard,* G. Schaller,** and F. Schopper**



This is a 12 second x-ray spectrum image (128x96 pixels)!

Update on Silicon Drift Detector (SDD) Performance

- Processing speed
- Spectral quality
 - -Resolution and peak position stability



For a given choice of time constant, the resolution should remain constant with deadtime.





Input Count Rate (kHz)



Bruker Quad SDD Data: Joe Michael, Sandia National Lab Albuquerque, NM

Why is this SDD so much faster?

Bruker "Tear-drop" Shaped SDD

OCR speed: On-chip integrated charge amplifier eliminates microphonics; off-center location protects amplifier from x-rays

Peak stability: pulse reset operation with reset diode integrated into the readout anode on the chip.



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M&M2006_Optimization of the Peak-to-Background Ratio and the Low Energy Response of Silicon Drift Detectors for High Resolution X-ray Spectroscopy

A. Niculae*, H.Soltau*, P.Lechner*, A.Liebl*, G. Lutz**, L. Strüder**, A. Longoni***

R. Eckhard*, G. Schaller** and F. Schopper**

Update on Silicon Drift Detector (SDD) Performance

- Processing speed
- Spectral quality
 - -Resolution and peak position stability
 - -Low photon energy peaks



Low photon energy performance






C K



C K



CK



Optimum Performance for Microanalysis with Silicon Drift Detectors with Integrated FET

A. Niculae*, H.Soltau*, P.Lechner*, A.Liebl*, G. Lutz*, L. Strüder**, R. Eckhard*, G. Schaller** and F. Schopper**

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Fig. 2 a) Carbon spectrum measured with a 10 mm² SD³ detector with optimized EW (pnWindow); b) Spectrum of ⁵⁵Fe source measured with 10 mm² SD³ detectors with standard and optimized EW.



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Fast X-ray Mapping with Excellent Light Element Performance from an SDD

Del Redfern, Alan Sandborg and Bob Anderhalt

EDAX Inc, 91 McKee Drive, Mahwah, NJ 07430

Microsc Microanal 13(Suppl 2), 2007

1371 CD



Figure 1: Light element spectra from the Apollo 40 SDD

Update on Silicon Drift Detector (SDD) Performance

- Processing speed
- Spectral quality
 - -Resolution and peak position stability
 - -Low photon energy peaks
 - -Coincidence peaks



3rd Generation SDD (Radiant Detectors LLC)





1434 CD DOI: 10.1017/S1431927607078312 Microsc Microanal 13(Suppl 2), 2007 Copyright 2007 Microscopy Society of America

Improved EDS Pileup Rejection for Low Energies at High Count Rates

R. B. Mott

PulseTor LLC, 328 Rileyville Road, Ringoes, NJ 08551-1501



FIG. 2. Sample is contaminated Cu: (a) Bruker XFlash[™] detector with Bruker pulse processing; (b) Bruker XFlash[™] detector with PulseTor pulse processing.

1428 CD DOI: 10.1017/S1431927607073242

Digital pulse processing and pile up correction for accurate interpretation of high rate SDD spectrum images

P.J.Statham



Fig.1 : X-ray data obtained at 250kcps. Conventional x-ray maps show integrated intensity for energy windows spanning each elemental peak Top spectrum is average over bright region in Sn t area bottom right of K map.



Fig.2 : Same spectral image data as for fig.1. Quantitative element maps obtained after applying pileup correction algorithm to spectra at individual pixels, then using digital filter and least squares fitting of peak profiles to subtract background and resolve peak overlaps.

- To exploit this OCR speed for mapping (e.g., by x-ray spectrum imaging), we need:
- Suitably intense x-ray production, that is, an SEM that can deliver high beam currents (10 – 1000 nA) and a specimen that can withstand high dose without degradation.

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- Low (ideally "no") overhead x-ray event processing (try to avoid wasting time sorting and storing "no information" channels)



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- Suitably intense x-ray production, that is, an SEM that can deliver high beam currents (10 – 1000 nA) and a specimen that can withstand high dose without degradation.
- Low (ideally "no") overhead x-ray event processing: use "position tagged spectrometry" implemented as "event streaming in hardware", e.g., see:

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Event Streamed Spectrum Imaging (ESSI)

Scott D. Davilla

4pi Analysis Inc, 3500 Westgate Dr, Suite 403, Durham, North Carolina, 27707, USA

Efficient handling of data stream from SDD: Event Streaming (No overhead; move units of information)

X-ray events are outputted directly from the x-ray pulse processor's auxiliary interface bus into the x-y scan generator. The events are then interpreted and combined with the x-ray position information into pixel events. The pixel events are packetized and streamed to a host computer where they are buffered and stored. The whole process takes place at the hardware level with an extremely high speed and is thus highly efficient. (Pixel overhead μs rather than ms)

High Speed Spectrum Imaging of Raney Nickel Alloy Using a Large Area Silicon Multi-Cathode Detector (Vortex-EMTM) and Event Streaming Technique M&M 2006

L. Feng*, V. D. Saveliev*, S. Barkan*, C. R. Tull*, M. Takahashi*, N. Matsumori*, S. D. Davilla**, J. S. Iwanczyk***, D. E. Newbury**** and J. A. Small****

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- 2. Low (ideally "no") overhead x-ray event processing: use "position tagged spectrometry" implemented as "event streaming in hardware",

With these conditions reasonably satisfied: Specimen: Portland St. Meteorite

OCR = 550kHz Quad SDD, resolution MnK α < 140 eV 128 x 96 pixels; 1 ms dwell per pixel = 12.3 seconds





S Fe Si







This is a 12 second x-ray spectrum image!

With x-ray spectrum imaging now possible in 10 to 100 seconds with optimized SDD:

- 1. How can we recover information buried in these ~ 100 Mbyte – 1 Gbyte files?
 - Sophisticated statistical approach, see:

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Rapid X-ray Spectrum Imaging with the Silicon Drift Detector (SDD): Multivariate Statistical Analysis

Paul G. Kotula¹, Joseph R. Michael¹, and Dale E. Newbury²

lo i ar i it i a all amongoood

- Simple minded, operator intensive approach:

NIST LISPIX (available for free at www.nist.gov; search "LISPIX")

LISPIX is a comprehensive image manipulation software engine that includes many tools that are useful for the study of x-ray spectrum images and extraction of information.

LISPIX "Derived Spectrum" Tools

• Two views of the x-ray spectrum image (XSI)

- As an array of true spectra, one at each pixel



LISPIX "Derived Spectrum" Tools

- Two views of the x-ray spectrum image (XSI)
 - As an array of true spectra, one at each pixel
 - As a "card deck" of x-ray images, each 10-eV wide

Cube slices are x-ray maps (images)

The x-ray spectrum image can be viewed as a card deck of x-ray images, each a 10-eV energy slice

X

A-ray Diversit



Y

LISPIX "Derived Spectrum" Tools

- Two views of the x-ray spectrum image (XSI)
 - As an array of true spectra, one at each pixel
 - As a "card deck" of x-ray images, each 10-eV wide
- Basis of Lispix approach: "derived spectra" SUM Spectrum
 - Add all counts on a card to find intensity for that keV

Derived x-ray spectra are calculated from measured spectra within the cube.



Channel (X-ray Energy)

LISPIX "Derived Spectrum" Tools

- Two views of the x-ray spectrum image (XSI)
 - As an array of true spectra, one at each pixel
 - As a "card deck" of x-ray images, each 10-eV wide

SUM Spectrum

- Add all counts on a card to find intensity for that keV
- Peaks identify high abundance features

Peaks in the SUM spectrum correspond to x-ray lines of elements.



Multichannel image for Ni peak.

Single 'slice' or x-ray channel

LISPIX constructs the image corresponding to an energy plane or group of energy planes.

Developing Derived Spectrum Tools

- SUM spectrum quickly locates spectral features with high abundance
- Problem: How do we find rare, <u>unanticipated</u> features in the datacube (200 Mbytes):
 - Rare feature may occur only at one pixel. For a 256x200 scan, one pixel represents 1/51,200
 - Any element (except H, He, Li) may be of interest

Maximum Pixel Spectrum



Channel (X-ray Energy)


LISPIX "Derived Spectrum" Tools

- Two views of the x-ray spectrum image (XSI)
 - As an array of true spectra, one at each pixel
 - As a "card deck" of x-ray images, each 10-eV wide
- SUM Spectrum
 - Add all counts on a card to find intensity for that keV
 - Peaks identify high abundance features
- MAX PIXEL Spectrum
 - Find maximum value on a card and plot for that keV
 - Locates rare, unanticipated features



LISPIX "Derived Spectrum" Tools

- Two views of the x-ray spectrum image (XSI)
 - As an array of true spectra, one at each pixel
 - As a "card deck" of x-ray images, each 10-eV wide
- SUM Spectrum
 - Add all counts on a card to find intensity for that keV
 - Peaks identify high abundance features
- MAX PIXEL Spectrum
 - Find maximum value on a card and plot for that keV
 - Locates rare, unanticipated features
 - May not be sensitive to dilute constituents
- RUNNING MAX Spectrum
 - First average over n-m to n+m cards (e.g., m = 3) to create new n_{average} card
 - Then perform maximum value search on n_{average} card







LISPIX "Derived Spectrum" Tools

- Two views of the x-ray spectrum image (XSI)
 - As an array of true spectra, one at each pixel
 - As a "card deck" of x-ray images, each 10-eV wide
- SUM Spectrum
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Log of the SUM Spectrum



Finding dilute iron with the Log of the Sum Spectrum



• How many counts are "enough" to establish visibility for an object in a compositional map?

- How many counts are "enough" to establish visibility for an object in a compositional map?
- The answer depends on several factors:
 - 1. The concentration, C (mass fraction)
 - 2. The characteristic x-ray energy
 - a. Overvoltage, $U_0 = E_0/E_c$ $I_{ch} \sim (U_0 1)^n$
 - **b.** Specimen self-absorption $I/I_0 = \exp[-(\mu/\rho) \rho s]$
 - c. X-ray detector efficiency

3. X-ray background (continuum) $I_{cm} \sim Z (U - 1)$ 4. The level of compositional contrast, e.g. vs. Bkg or

vs. a different concentration.

128x96 1 ms dwell, 10 frames 123 s total 550kHz OCR Al_{max}=3846



Background Corrected; Fe Contrast background

Fe_{max}=93

Phases AI 99.5 Ni 0.5 AI 71.2 Ni 24.6 Fe 4.2 AI 46.5 Ni 53.5

Al 60 Ni 40

This dose gives sufficient Fe counts to perform a background correction.

128x96 1 ms dwell, 10 frames 123 s total 550kHz OCR



Phases Al 99.5 Ni 0.5 AI 71.2 Ni 24.6 Fe 4.2 AI 46.5 Ni 53.5

AI 60 Ni 40 Reduce dose by 10; 128x96 1 ms dwell, 1 frame 12.3 s total 550kHz OCR

Fe_{max}= 9 A 10 um **AI Fe Ni**

Phases AI 60 AI 99.5 Ni 0.5 AI 71.2 Ni 24.6 Fe 4.2 AI 46.5 Ni 53.5

Ni 40

128x96 512 μs dwell, 1 frame 6.2 s total 550kHz OCR



 Phases
 AI 99.5 Ni 0.5
 AI 60
 Ni 40

 AI 71.2 Ni 24.6 Fe 4.2
 AI 46.5 Ni 53.5

128x96 256 μ s dwell, 1 frame 3.1 s total 550kHz OCR

Fe_{max}= 3



PhasesAI 99.5 Ni 0.5AI 60AI 71.2 Ni 24.6 Fe 4.2AI 46.5 Ni 53.5

128x96 128 μs dwell, 1 frame 1.6 s total 550kHz OCR

Fe_{max}= 2



 Phases
 AI 99.5 Ni 0.5
 AI 60
 Ni 40

 AI 71.2 Ni 24.6 Fe 4.2
 AI 46.5 Ni 53.5

- How many counts are "enough" to establish visibility for an object in a compositional map?
- This issue is closely related to the classic Rose (1948) criterion for contrast visibility threshold in scanned images. For an object relative to a featureless background, Rose requires the signal to exceed the noise by a factor ("Rose factor", RF) of at least 5:

Signal = $(n_2 - n_1) > RF * \sigma_n$ (noise) = RF $n_1^{1/2}$

Consider the case of a compositional feature containing element A viewed against a featureless background that does not contain element A

For x-rays, $n_1 = B$ (continuum) while $n_2 = P$ (characteristic) + B

Signal = $(n_2 - n_1) = (P+B - B) = P > RF B^{1/2}$

 $P/B > RF B^{1/2}/B$

 $P/B > RF/B^{1/2}$

P/B > 5/B^{1/2}



For an element localized in one phase







- How many counts are "enough" to establish visibility for an object in a compositional map?
- The answer depends on several factors:
 - 1. The concentration, C (mass fraction)
 - 2. The characteristic x-ray energy
 - a. Overvoltage, $U_0 = E_0/E_c$ $I_{ch} \sim (U_0 1)^n$
 - **b.** Specimen self-absorption $I/I_0 = \exp[-(\mu/\rho) \rho s]$
 - c. X-ray detector efficiency
 - 3. X-ray background (continuum) $I_{cm} \sim Z (U 1)$
 - 4. The level of compositional contrast, e.g. vs. B or vs. a different concentration.
- A compositional image simulator is needed:
 - DTSA for spectral details, such as P/B (soon NIST Monte)
 - LISPIX to synthesis and process the images for display



Desktop Spectrum Analyzer (DTSA) Simulation

Size Matters! Effect of Feature Size on Visibility

Feature: 1 pixel (Rose criterion) = 0.4% of image width (256 pixels)



Size Matters! Effect of Feature Size on Visibility

Feature: 5 pixels square = 2% of image width (256 pixels)



Size Matters! Effect of Feature Size on Visibility

Feature: 64 pixels square = 25% of image width (256 pixels)



B = 25 counts See: Bright, D. S., Newbury, D. E., and Steel, E. B., "Visibility of objects in computer simulations of noisy micrographs", J. Micros., 189 (1998) 25-42.

Conclusions

- SDD performance enables XSI mapping in 10 to 200 seconds (512x394_1ms) if the specimen can withstand the high beam current necessary to generate high x-ray flux.
- NIST LISPIX interactive tools enable detection and recovery of compositional features, including those that are rare and unanticipated.
- Strategy for mapping can be developed with the spectral simulation tool in NIST DTSA and the new image simulation tool embedded in NIST LISPIX.

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